



flowPIM 0

650 V / 20 A

Topology features

- Converter+Inverter
- Open Emitter configuration
- Temperature sensor

Component features

- Easy paralleling
- Low collector emitter saturation voltage
- Low turn-off losses
- Positive temperature coefficient

Housing features

- Base isolation: Al₂O₃
- Clip-in, reliable mechanical connection, qualified for wave soldering
- Convex shaped substrate for superior thermal contact
- Thermo-mechanical push-and-pull force relief
- Solder pin

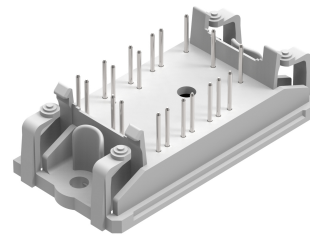
Target applications

- Embedded Drives
- HVAC
- Industrial Drives

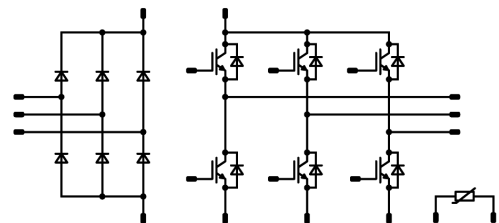
Types

- 10-F407PNA020I7-P445C69

flow 0 17 mm housing



Schematic





Vincotech

10-F407PNA020I7-P445C69
datasheet

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Inverter Switch				
Collector-emitter voltage	V_{CES}		650	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	32	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	60	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	58	W
Gate-emitter voltage	V_{GES}		± 20	V
Short circuit ratings	t_{SC}	$V_{GE} = 15\text{ V}$, $V_{CC} = 400\text{ V}$ $T_j = 150\text{ °C}$	3	μs
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$
Inverter Diode				
Peak repetitive reverse voltage	V_{RRM}		650	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	23	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	60	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	37	W
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$
Rectifier Diode				
Peak repetitive reverse voltage	V_{RRM}		1600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	39	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 150\text{ °C}$	270	A
Surge current capability	I^2t		370	A^2s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	44	W
Maximum junction temperature	T_{jmax}		150	$^{\circ}\text{C}$



Vincotech

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datasheet

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
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Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	°C
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	°C

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage* $t_p = 2\text{ s}$	4000	V
Creepage distance			>12,7	mm
Clearance			>12,7	mm
Comparative Tracking Index	CTI		≥ 200	

*100 % tested in production



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Inverter Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,0002	25	4,35	5	5,65	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		20	25 125 150		1,32 1,4 1,43	1,65 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	650		25			20	μA
Gate-emitter leakage current	I_{GES}		20	0		25			100	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{ies}							1310		pF
Output capacitance	C_{oes}	$f = 1$ Mhz	0	25		25		42		pF
Reverse transfer capacitance	C_{res}							13		pF
Gate charge	Q_g	$V_{CC} = 520$ V	15		20	25		128		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,63		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$					25 125 150		90,8 93,01 93,57		ns
Rise time	t_r					25 125 150		38,54 38,79 38,74		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		118,1 139,16 143,85		ns
Fall time	t_f					25 125 150		31,44 55,29 61,87		ns
Turn-on energy (per pulse)	E_{on}	$Q_{tFWD} = 0,504$ μC $Q_{tFWD} = 1,11$ μC $Q_{tFWD} = 1,31$ μC				25 125 150		0,733 0,972 1,03		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		0,45 0,66 0,715		mWs



Vincotech

10-F407PNA020I7-P445C69
datasheet

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		
Inverter Diode										
Static										
Forward voltage	V_F				20	25 125 150		1,71 1,6 1,55	2 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 650$ V				25			20	μA
Thermal										
Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						2,59		K/W
Dynamic										
Peak recovery current	I_{RM}	$di/dt=572$ A/μs $di/dt=548$ A/μs $di/dt=607$ A/μs	±15	350	30	25		8,24		A
Reverse recovery time	t_{rr}					125		12,58		
						150		13,56		
						25		97,26		
Recovered charge	Q_r					125		143,97		
						150		160,25		
		25		0,504						
Reverse recovered energy	E_{rec}	125		1,11						
		150		1,31						
		25		0,097						
Peak rate of fall of recovery current	$(di_r/dt)_{max}$	125		0,225						
		150		0,269						
		25		354,08						
						125		220,3		A/μs
						150		183,54		



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Rectifier Diode

Static

Forward voltage	V_F				13	25 125 150		0,983 0,89 0,869	1,21 ⁽¹⁾ 1,1 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 1600$ V				25			50	μA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,59		K/W
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Thermistor

Static

Rated resistance	R					25		22		kΩ
Deviation of R100	$\Delta_{R/R}$	$R_{100} = 1484$ Ω				100	-5		5	%
Power dissipation	P					25		130		mW
Power dissipation constant	d					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. ±1 %						3962		K
B-value	$B_{(25/100)}$	Tol. ±1 %						4000		K
Vincotech Thermistor Reference									I	

⁽¹⁾ Value at chip level

⁽²⁾ Only valid with pre-applied Vincotech thermal interface material.

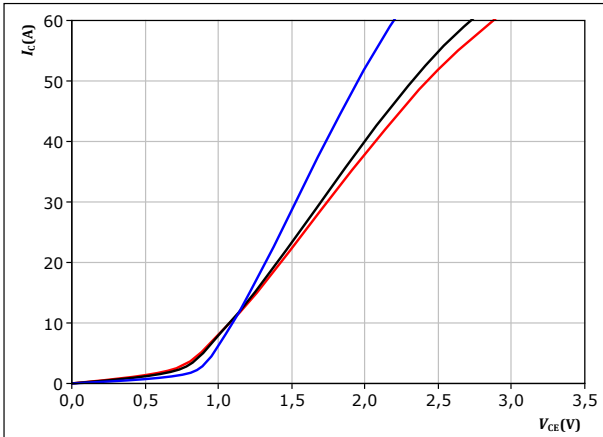


Inverter Switch Characteristics

figure 1. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$



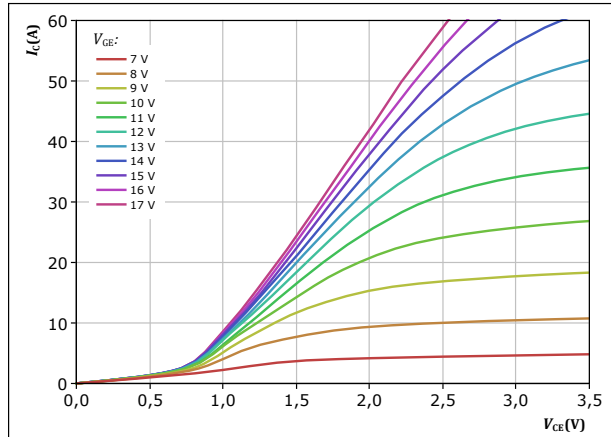
$t_p = 250\ \mu\text{s}$
 $V_{GE} = 15\ \text{V}$

$T_j:$ — 25 °C
— 125 °C
— 150 °C

figure 2. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

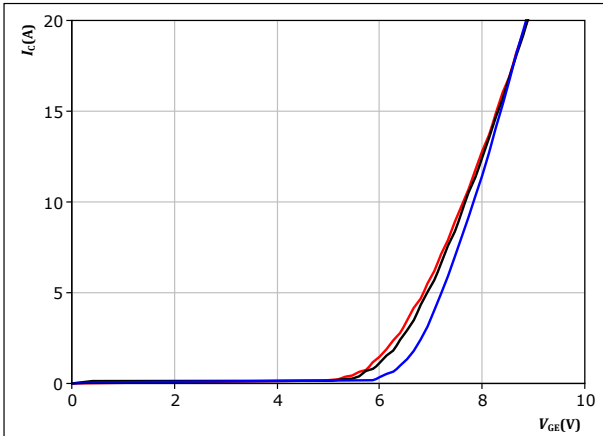


$t_p = 250\ \mu\text{s}$
 $T_j = 150\text{ °C}$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 3. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$



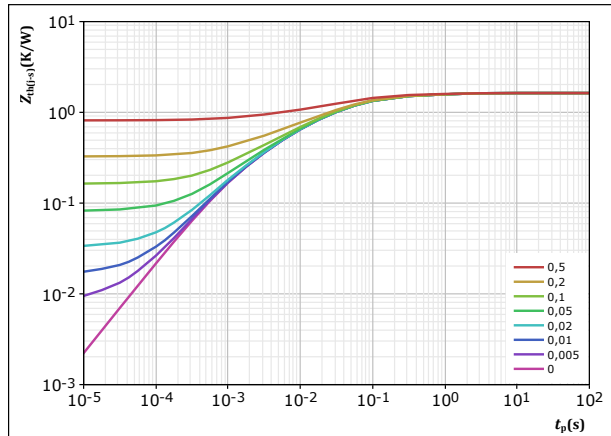
$t_p = 250\ \mu\text{s}$
 $V_{CE} = 9\ \text{V}$

$T_j:$ — 25 °C
— 125 °C
— 150 °C

figure 4. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,631\ \text{K/W}$

IGBT thermal model values

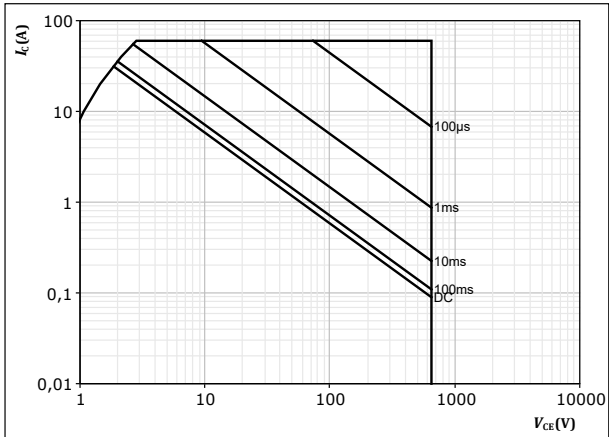
R (K/W)	τ (s)
1,22E-01	1,15E+00
3,54E-01	1,26E-01
6,61E-01	2,93E-02
3,54E-01	5,82E-03
1,40E-01	1,02E-03



Inverter Switch Characteristics

figure 5. IGBT

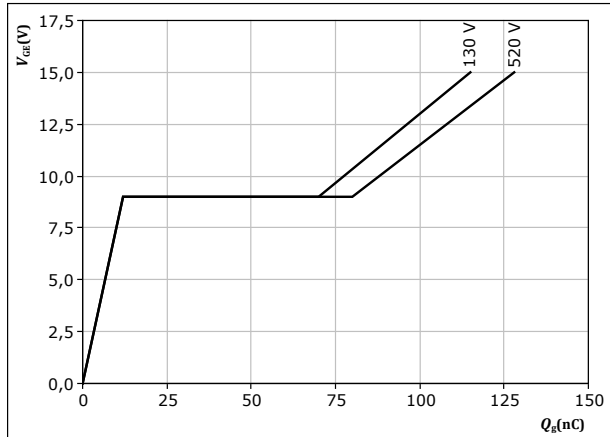
Safe operating area
 $I_C = f(V_{CE})$



$D =$ single pulse
 $T_s = 80$ °C
 $V_{GE} = 15$ V
 $T_j = T_{jmax}$

figure 6. IGBT

Gate voltage vs gate charge
 $V_{GE} = f(Q_g)$



$I_C = 20$ A
 $T_j = 25$ °C



Inverter Diode Characteristics

figure 7. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

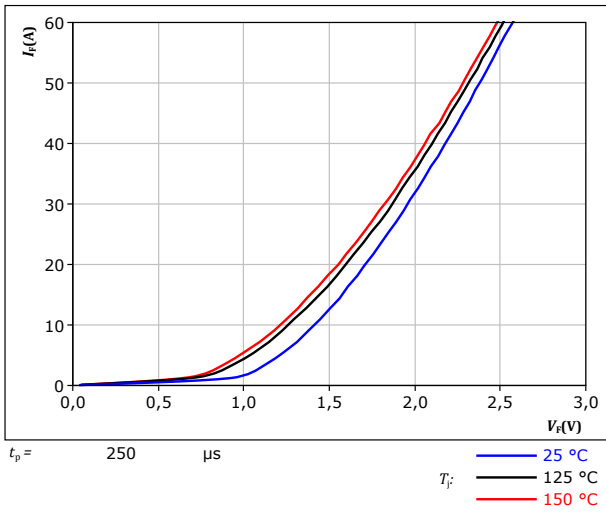
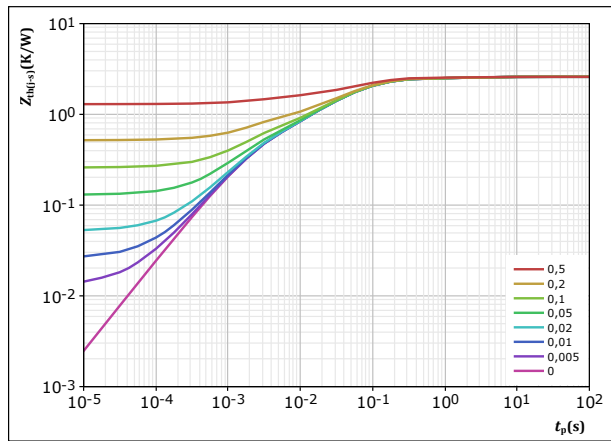


figure 8. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	t_p / T	
$R_{th(j-s)} =$	2,592	K/W
FWD thermal model values		
R (K/W)	τ (s)	
7,36E-02	3,57E+00	
5,92E-02	1,43E+00	
1,09E+00	9,46E-02	
9,44E-01	2,55E-02	
4,28E-01	2,15E-03	



Rectifier Diode Characteristics

figure 9. Rectifier

Typical forward characteristics

$$I_F = f(V_F)$$

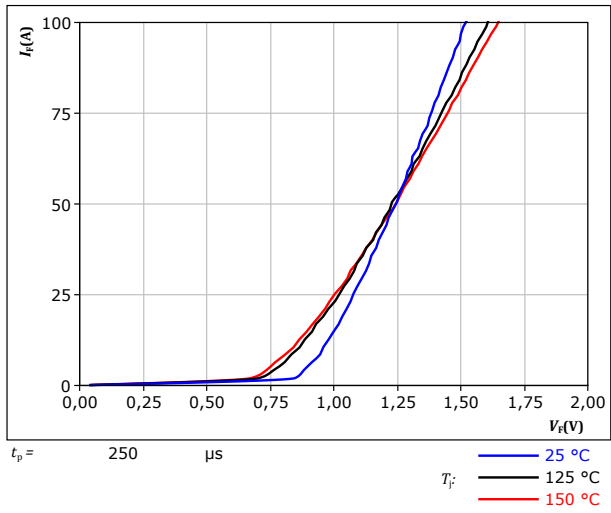
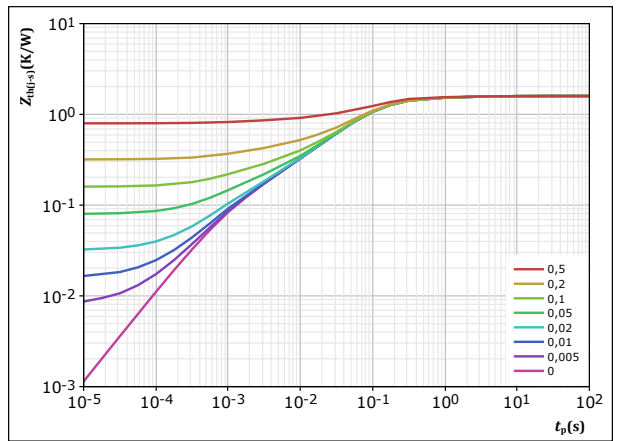


figure 10. Rectifier

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = \frac{t_p}{T}$
 $R_{th(j-s)} = 1,592 \text{ K/W}$
 Rectifier thermal model values

R (K/W)	τ (s)
5,25E-02	3,88E+00
2,04E-01	4,78E-01
1,08E+00	7,99E-02
1,71E-01	9,86E-03
8,68E-02	1,04E-03

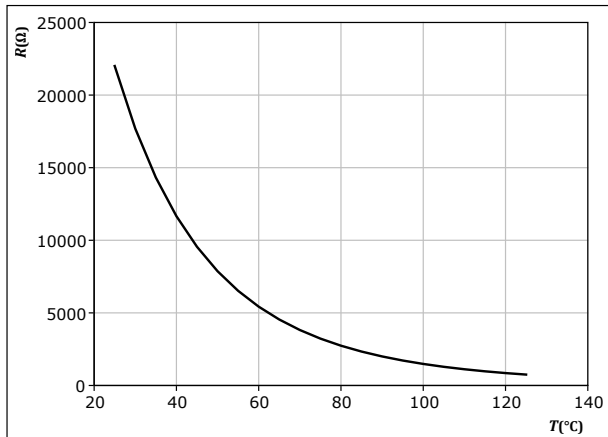


Thermistor Characteristics

figure 11. Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$

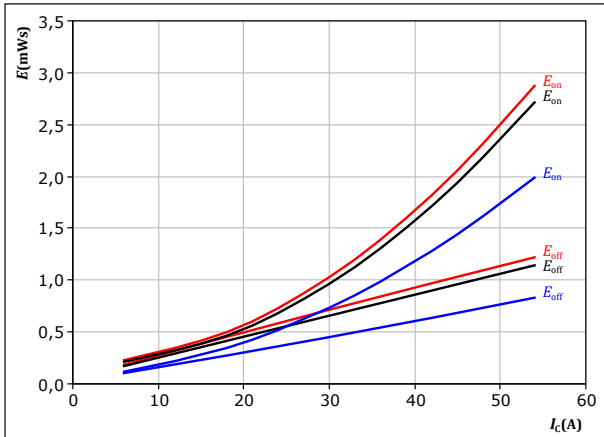




Inverter Switching Characteristics

figure 12. IGBT

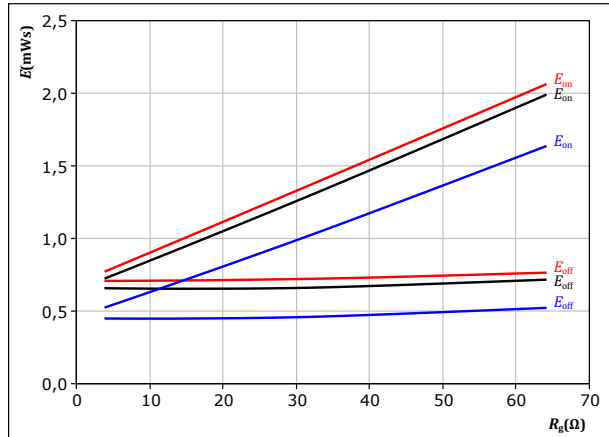
Typical switching energy losses as a function of collector current
 $E = f(I_c)$



With an inductive load at
 $V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 16$ Ω
 $R_{goff} = 16$ Ω
 T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 13. IGBT

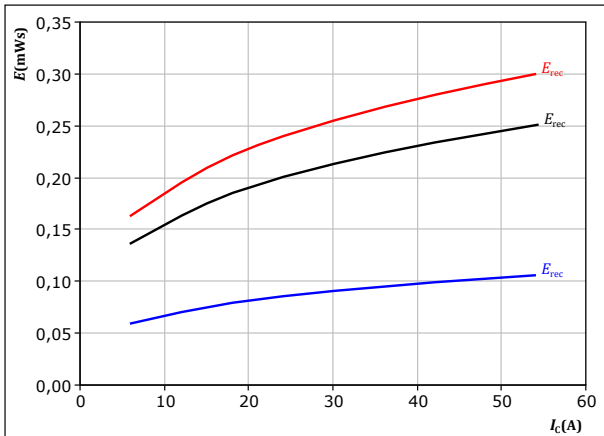
Typical switching energy losses as a function of IGBT turn on gate resistor
 $E = f(R_g)$



With an inductive load at
 $V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 30$ A
 T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 14. FWD

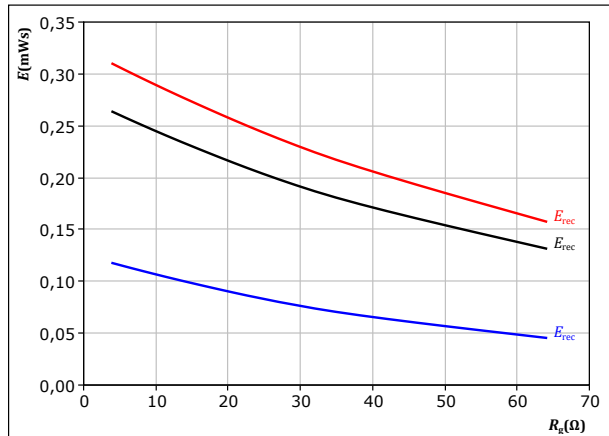
Typical reverse recovered energy loss as a function of collector current
 $E_{rec} = f(I_c)$



With an inductive load at
 $V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 16$ Ω
 T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 15. FWD

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor
 $E_{rec} = f(R_g)$



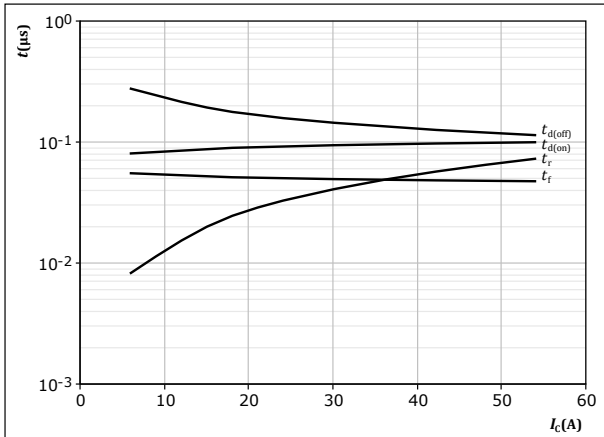
With an inductive load at
 $V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 30$ A
 T_j : 25 °C (blue), 125 °C (black), 150 °C (red)



Inverter Switching Characteristics

figure 16. IGBT

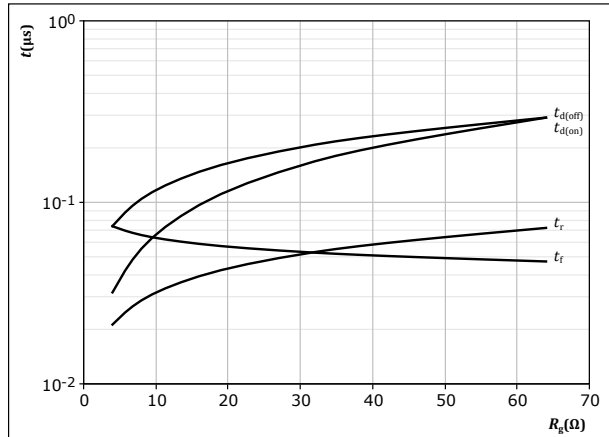
Typical switching times as a function of collector current
 $t = f(I_c)$



With an inductive load at
 $T_j = 150 \text{ }^\circ\text{C}$
 $V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 16 \text{ } \Omega$
 $R_{goff} = 16 \text{ } \Omega$

figure 17. IGBT

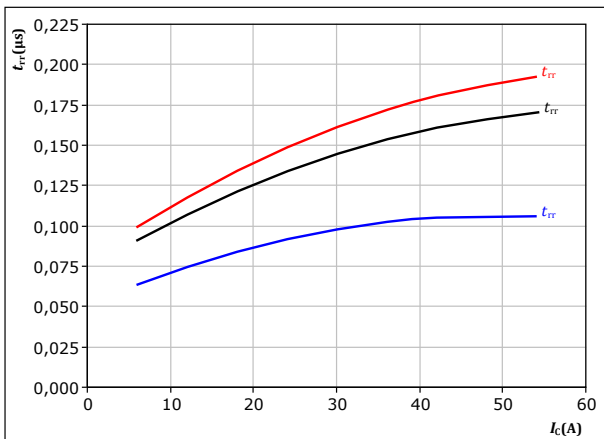
Typical switching times as a function of IGBT turn on gate resistor
 $t = f(R_g)$



With an inductive load at
 $T_j = 150 \text{ }^\circ\text{C}$
 $V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 30 \text{ A}$

figure 18. FWD

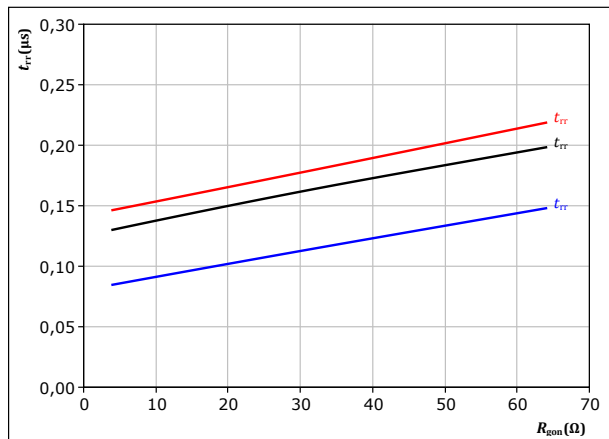
Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_c)$



With an inductive load at
 $V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 16 \text{ } \Omega$
 $T_j:$ — 25 °C
 — 125 °C
 — 150 °C

figure 19. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor
 $t_{rr} = f(R_{gon})$



With an inductive load at
 $V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 30 \text{ A}$
 $T_j:$ — 25 °C
 — 125 °C
 — 150 °C

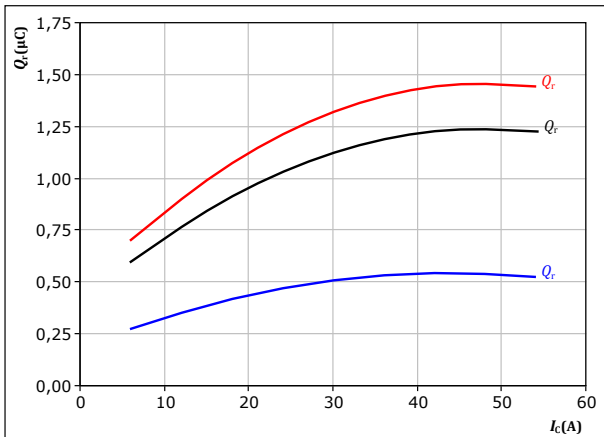


Inverter Switching Characteristics

figure 20. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

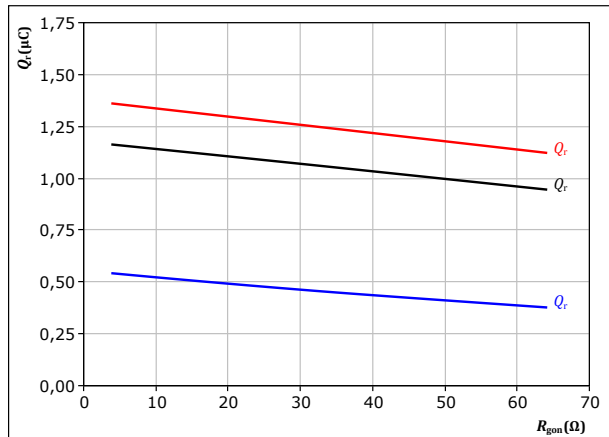
$V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 16 \ \Omega$

T_j : — 25 °C
— 125 °C
— 150 °C

figure 21. FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$



With an inductive load at

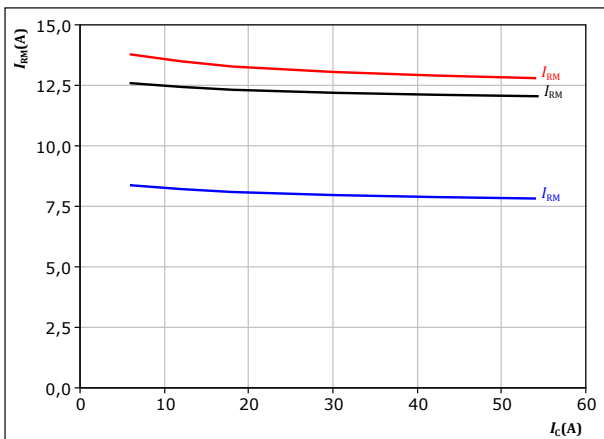
$V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 30 \text{ A}$

T_j : — 25 °C
— 125 °C
— 150 °C

figure 22. FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

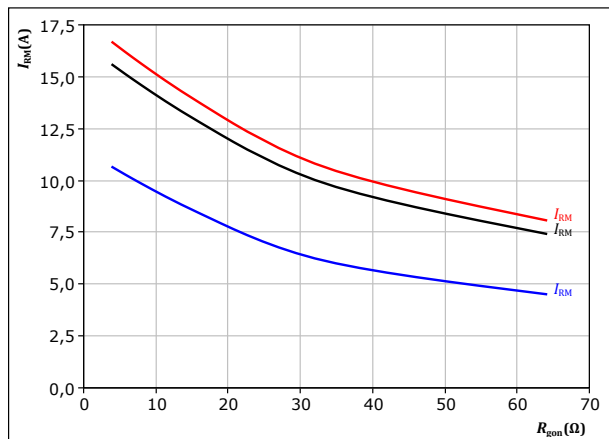
$V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 16 \ \Omega$

T_j : — 25 °C
— 125 °C
— 150 °C

figure 23. FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

$V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 30 \text{ A}$

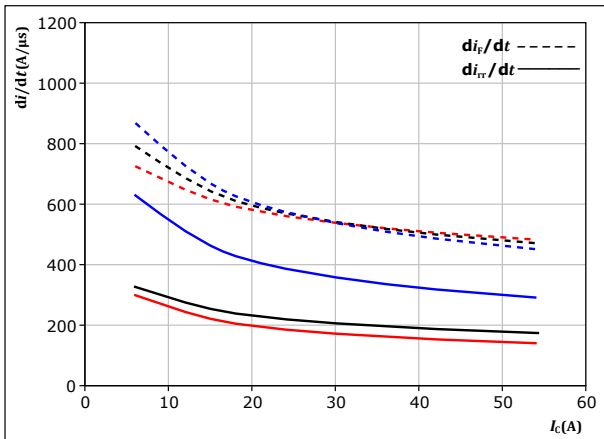
T_j : — 25 °C
— 125 °C
— 150 °C



Inverter Switching Characteristics

figure 24. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_c)$



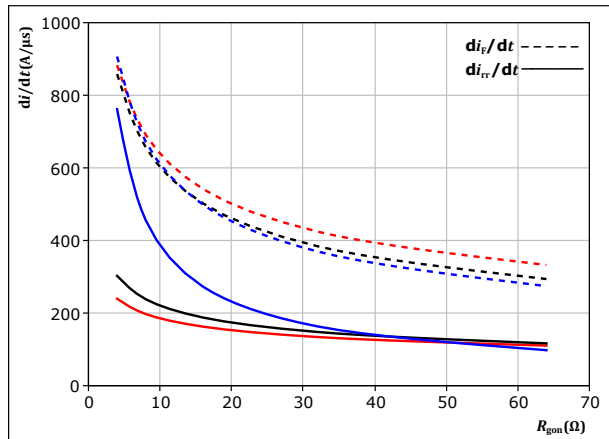
With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 16$ Ω

T_j : 25 °C
 125 °C
 150 °C

figure 25. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{gon})$



With an inductive load at

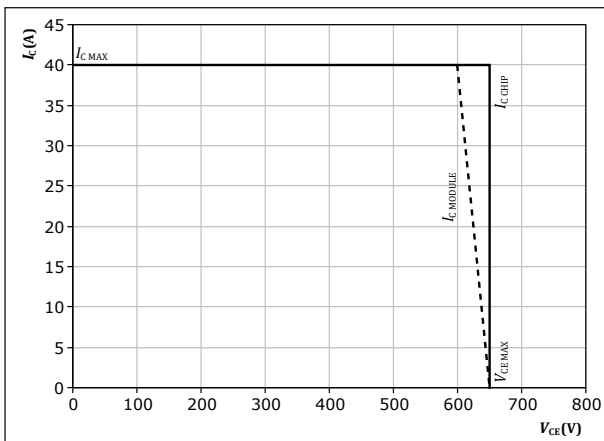
$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 30$ A

T_j : 25 °C
 125 °C
 150 °C

figure 26. IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



At $T_j = 150$ °C
 $R_{gon} = 16$ Ω
 $R_{goff} = 16$ Ω



Inverter Switching Definitions

figure 27. IGBT

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

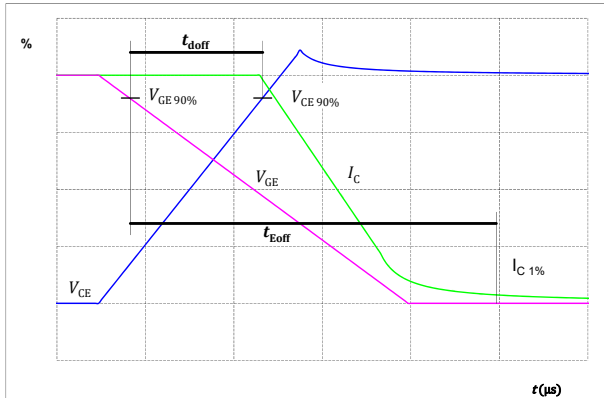


figure 28. IGBT

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

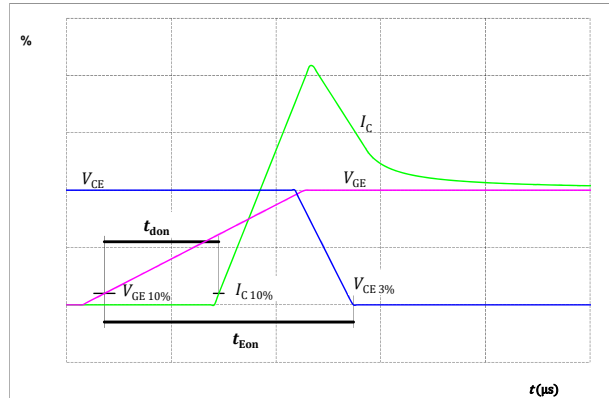


figure 29. IGBT

Turn-off Switching Waveforms & definition of t_f

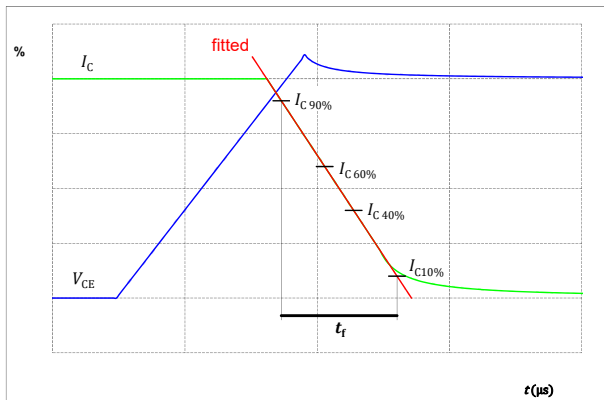
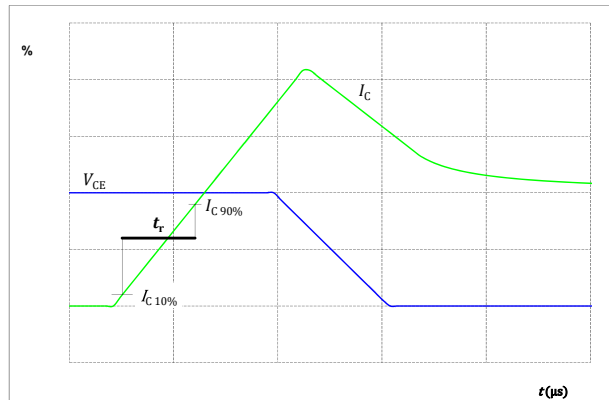


figure 30. IGBT

Turn-on Switching Waveforms & definition of t_r





Inverter Switching Definitions

figure 31. FWD

Turn-off Switching Waveforms & definition of t_{rr}

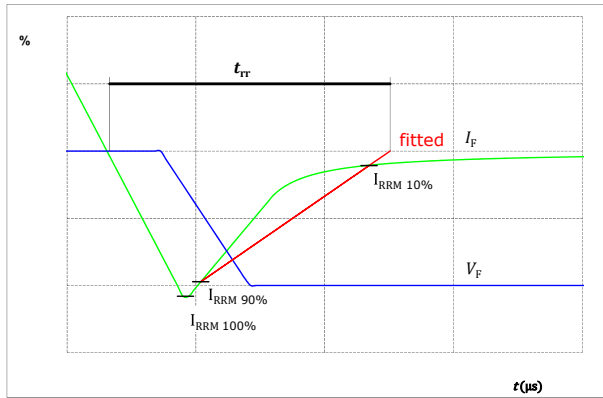
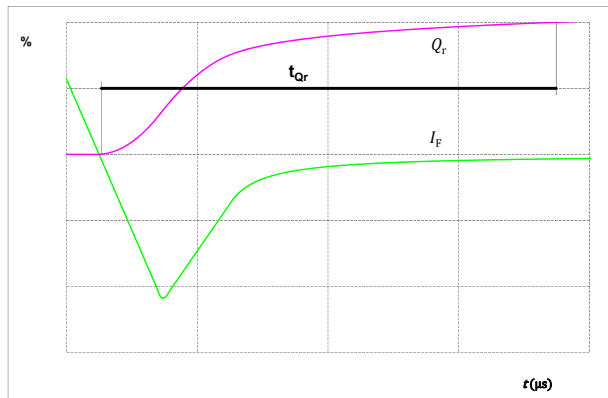


figure 32. FWD

Turn-on Switching Waveforms & definition of t_{Qr} (t_{Qr} = integrating time for Q_r)





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10-F407PNA020I7-P445C69
datasheet

Ordering Code	
Version	Ordering Code
Without thermal paste	10-F407PNA020I7-P445C69
With thermal paste (5,2 W/mK, PTM6000HV)	10-F407PNA020I7-P445C69-/7/

Marking							
	Text	VIN VIN	Date code WWYY	Type&Ver TTTTTTV	UL UL	Lot LLLLL	Serial SSSS
	Datamatrix	Type&Ver	Lot number	Serial	Date code		
		TTTTTTV	LLLLL	SSSS	WWYY		

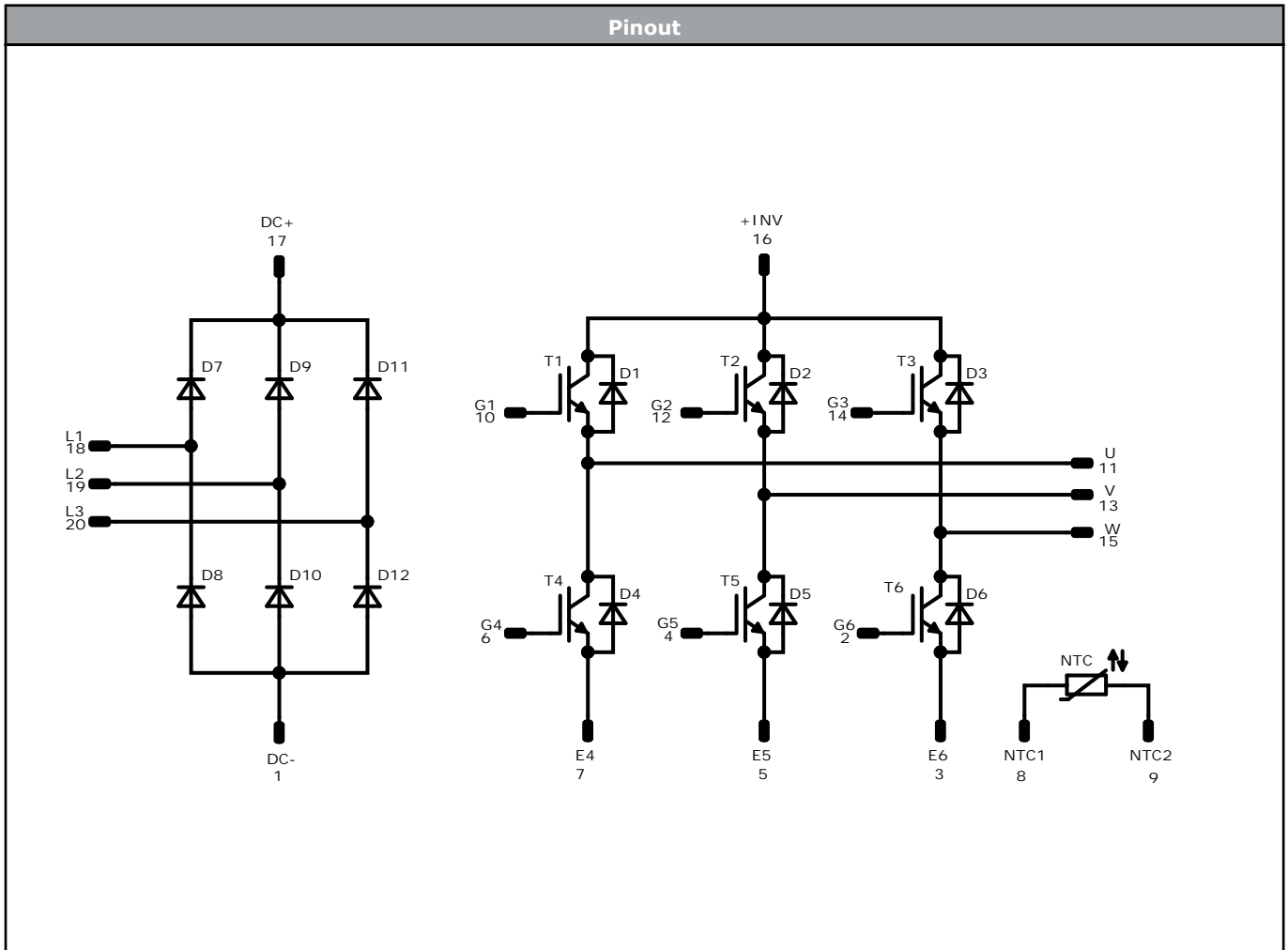
Pin table [mm]			
Pin	X	Y	Function
1	24,3	0	DC-
2	20,8	0	G6
3	18,1	0	E6
4	12,6	0	G5
5	9,9	0	E5
6	5	0	G4
7	2,3	0	E4
8	0	8,9	NTC1
9	0	11,6	NTC2
10	0	19,8	G1
11	0	22,5	U
12	8	19,8	G2
13	8	22,5	V
14	16	19,8	G3
15	16	22,5	W
16	22,8	22,5	+INV
17	25,5	22,5	DC+
18	33,5	22,5	L1
19	33,5	14	L2
20	33,5	5,5	L3

$\phi 1 \pm 0,05$
 $212 \pm 0,5$
 $11,25$
 $16,75$

Tolerance of pinpositions: $\pm 0,5$ mm at the end of pins
Dimension of coordinate axis is only offset without tolerance



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Identification					
ID	Component	Voltage	Current	Function	Comment
T4, T1, T5, T2, T6, T3	IGBT	650 V	20 A	Inverter Switch	
D1, D4, D2, D5, D3, D6	FWD	650 V	20 A	Inverter Diode	
D8, D7, D10, D9, D12, D11	Rectifier	1600 V	35 A	Rectifier Diode	
NTC	Thermistor			Thermistor	



Packaging instruction				
Standard packaging quantity (SPQ) 135	>SPQ	Standard	<SPQ	Sample

Handling instruction
Handling instructions for <i>flow 0</i> packages see vincotech.com website.

Package data
Package data for <i>flow 0</i> packages see vincotech.com website.

Vincotech thermistor reference
See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number
This device is UL 1557 recognized under E192116 up to a junction temperature under switching condition $T_{j,op}=175^{\circ}C$ and up to 3500VAC/1min isolation voltage. For more information see vincotech.com website.



Document No.:	Date:	Modification:	Pages
10-F407PNA02017-P445C69-D1-14	13 Sep. 2024	Initial Release	

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.